PI90LV032A
PI90LV028A
PI90LV018A

3V LVDS High-Speed Differential Line Receivers

Features

- Signaling Rates >400Mbps (200 MHz)
- Single 3.3V Power Supply Design
- Accepts ±350mV (typical) Differential Swing
- Maximum Differential Skew of 0.35ns
- Maximum Propagation Delay of 3.3ns
- Low Voltage TTL (LVTTL) Outputs
- Industrial Temperature Operating Range: -40°C to 85°C
- Open, Short, and Terminated Fail Safe
- Meets or Exceeds IEEE 1596.3 SCI Standard
- Meets or Exceeds ANSI/TIA/EIA-644 LVDS Standard
- Packaging (Pb-free & Green avaliable): - SOIC, TSSOP, and MSOP

Description

The PI90LV032A, PI90LV028A, and PI90LV018A are differential line receivers that use low-voltage differential signaling (LVDS) to support data rates in excess of 400 Mbps. These products are designed for applications requiring high-speed, low-power consumption and low noise generation.

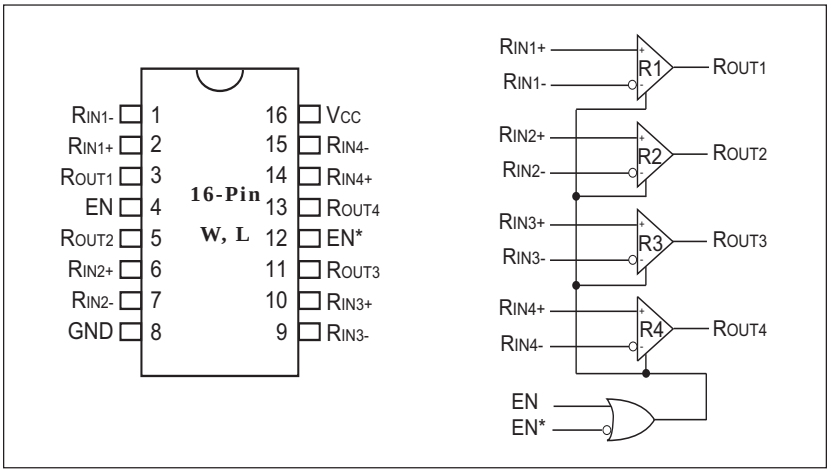
A differential input signal (350mV) is translated by the device to 3V CMOS output level. Exclusive to the PI90LV032A quad receiver is a power-down mode that Three-states the outputs and places the device in a low-power idle state (40mW typical).

Applications

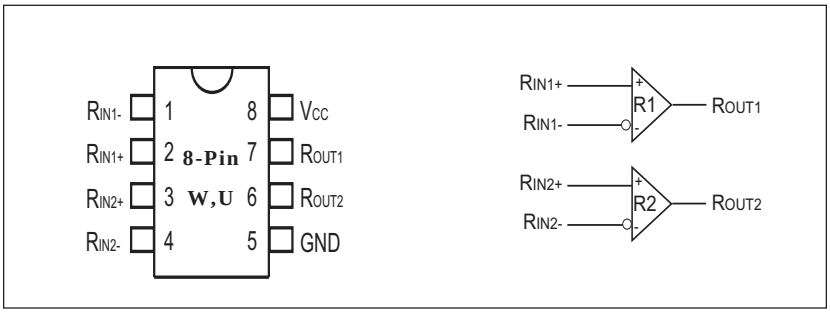
Applications include point-to-point and multidrop baseband data transmission over controlled impedance media of approximately 100 Ohms. The transmission media can be printed circuit board traces, backplanes, or cables.

The PI90LV032A, PI90LV028A, PI90LV018A and companion line drivers (PI90LV031A, PI90LV027A, and PI90LV017A) provide new alternatives to RS-232, PECL, and ECL devices for high-speed, point-to-point interface applications.

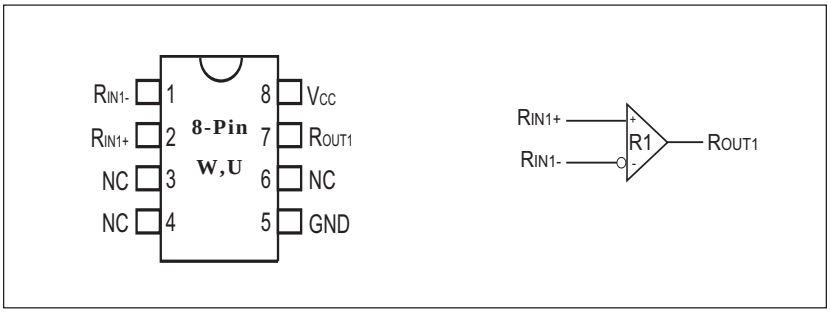
PI90LV032A



PI90LV028A



PI90LV018A



Function Tables

PI90LV032A

Enables		Inputs		Output
EN	**EN***	**R_{IN+}**	**R_{IN-}**	**R_{OUT}**
H	X	H	L	H
H	X	L	H	L
X	L	H	L	H
X	L	L	H	L
L	H	X	X	Z

PI90LV028A

Inputs		Output
R_{IN+}	**R_{IN-}**	**R_{OUT}**
H	L	H
L	H	L

PI90LV018A

Inputs		Output
R_{IN+}	**R_{IN-}**	**R_{OUT}**
H	L	H
L	H	L

Recommended Operating Conditions

	Min.	Typ.	Max.	Units
Supply Voltage (V_{CC})	+3.0	+3.3	+3.6	V
Receiver Input Voltage	GND		+3.0	
Operating Free Air Temperature (T_A)	-40	+25	+85	°C

Pin Descriptions

Name	Description
R_{OUT}	TTL/CMOS receiver output pins
R_{IN+}	Non-inverting receiver input pins
R_{IN-}	Inverting receiver input pins
GND	Ground pin
V_{CC}	Positive power supply pin, +3.3V ±10%

Absolute Maximum Ratings (see Note 1, Page 4)

Supply Voltage (V_{CC}) ..... –0.3V to +4.0V
Input Voltage (R_{IN+}, R_{IN-}) ..... –0.3V to +3.9V
Enable Input Voltage (EN, EN*) ..... –0.3V to (V_{CC} +0.3V)
Output Voltage (R_{OUT}) ..... –0.3V to (V_{CC} +0.3V)
S Package 750mW
Derate S Package ..... 8.2mW/°C above +25°C
Storage Temperature Range ..... -65°C to +150°C
Lead Temperature Range Soldering (4s) ..... +260°C
Maximum Junction Temperature ..... +150°C
ESD Rating ..... ≥6kV

Note:
Stresses greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Electrical Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified. (Note 2)

Symbol	Parameter	Conditions		Pin	Min.	Typ.	Max.	Units
V_{TH}	Differential Input High Threshold	Vcm = +1.2V(12)		R_{IN+}, R_{IN-}		+20	+100	mV
V_{TL}	Differential Input Low Threshold				-100	-20		
VCMR	Common-Mode Voltage Range	V_{ID} = 200mV peak-to-peak(5)			0.1		2.3	V
I_{IN}	Input Current	V_{IN} = +2.8V	V_{CC} = +3.6 or 0V		-10	±1	+10	µA
		V_{IN} = 0V			-10	±1	+10	
		V_{IN} = +3.6V	V_{CC} = 0V		-20		+20	
V_{OH}	Output High Voltage	I_{OH} = -0.4mA, V_{ID} = +200mV		R_{OUT}	2.7	3.0		V
		I_{OH} = -0.4mA, Input terminated			2.7	3.0		
		I_{OH} = -0.4mA, Input shorted			2.7	3.0		
V_{OL}	Output Low Voltage	I_{OL} = 2mA, V_{ID} = -200mV				0.1	0.25	
I_{OS}	Output Short Circuit Current	Enabled, Vout = 0V(10)			-15	-48	-120	mA
I_{OZ}	Output Three-State Current	Disabled, V_{OUT} = 0V or V_{CC}			-10	±1	+10	µA
V_{IH}	Input High Voltage			EN, EN*	2.0		V_{CC}	V
V_{IL}	Input Low Voltage				GND		0.8	
I_I	Input Current	V_{IN} = 0V or V_{CC}, Other Input = V_{CC} or GND			-10	±1	+10	µA
V_{CL}	Input Clamp Voltage	I_{CL} = -18mA			-1.5	-0.8		V
I_{CC}	No Load Supply Current Receivers Enabled	EN, EN* = V_{CC} or GND, Inputs Open		V_{CC}		10	15	mA
		EN, EN* = 2.4V or 0.5V, Inputs Open				10	15	
I_{CCZ}	No Load Supply Current Receivers Disabled	EN = GND, EN* = V_{CC}, Inputs Open				7	10	

Switching Characteristics

Over supply voltage and operating temperature ranges, unless otherwise specified. (Notes 3,4,7,8)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
t_{PHLD}	Differential Propagation Delay High to Low (V_{CM} = 1.2V)	C_L = 10pF, V_{ID} = 200mV (Figures 1 & 2)	1.8		4.7	ns
t_{PLHD}	Differential Propagation Delay Low to High (V_{CM} = 1.2V)		1.8		4.7	
t_{SKD1}	Differential Pulse Skew | t_{PHLD} - t_{PLHD} |(6)		0	0.1	0.35	
t_{SKD2}	Differential Channel-to-Channel Skew-same device(7)		0	0.1	0.5	
t_{SKD3}	Differential Part-to-Part Skew(8)				1.0	
t_{SKD4}	Differential Part-to-Part Skew(9)				1.5	
t_{TLH}	Rise Time			0.35	1.2	
t_{THL}	Fall Time			0.35	1.2	
t_{PHZ}	Disable Time High to Z	R_L = 2KΩ		8	12	
t_{PLZ}	Disable Time Low to Z	C_L = 10pF (Figures 3 & 4)		6	12	
t_{PZH}	Enable Time Z to High			11	17	
t_{PZL}	Enable Time Z to Low			11	17	
t_{MAX}	Maximum Operating Frequency(13)	All channels switching	200	250		MHz

Notes:

1. "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" specifies conditions of device operation.
2. Current into device pins is defined as positive. Current out of device pins is defined as negative. All voltages are referenced to ground unless otherwise specified.
3. All typicals are given for: V_{CC} = +3.3V, T_A = +25°C.
4. Generator waveform for all tests unless otherwise specified: f = 1 MHz, Z_O = 50Ω, t_R and t_F (0% to 100%) ≤ 3ns for R_{IN}.
5. The VCMR range is reduced for larger VID. Example : if VID = 400mV, the VCMR is 0.2V to 2.2V. The fail-safe condition with inputs shorted is valid over a common-mode range of 0V to 2.3V. A VID up tp V_{CC} - 0V may be applied to the R_{IN+} / R_{IN-} inputs with the Common-Mode voltage set to V_{CC}/2. Propagation delay and Differential Pulse skew decrease when VID is increased from 200mV to 400mV. Skew specifications apply for 200mV ≤ VID ≤ 800mV over the common mode range.
6. tskd1 is the magnitude difference in differential propagation delay time between the positive going edge and the negative going edge of the same channel.
7. t_{SKD2}, Channel-to-Channel Skew, is defined as the difference between the propagation delay of one channel and that of the others on the same chip with any event on the inputs.
8. t_{SKD3}, Part-to-Part Skew, is the differential Channel-to-Channel skew of any event between devices. This specification applies to devices at the same V_{CC},and within 5ºC of each other within the operating temperature range.
9. t_{SKD4}, Part-to-Part Skew, is the differential Channel-to-Channel skew of any event between devices. This specification applies to devices over recommended operating temperature and voltage ranges, and across process distribution. tskd4 is defined as lMax - Mini differential propagation delay.
10. Output short circuit current (I_{OS}) is specified as magnitude only, minus sign indicates direction only. Only one output should be shorted at a time, do not exceed maximum junction temperature specification.
11. C_L includes probe and jig capacitance.
12. V_{CC} is always higher than R_{IN+} and R_{IN-} voltage. R_{IN-} and R_{IN+} are allowed to have a voltage range -0.2V to V_{CC}- VID/2. However, to be compliant with AC specifications, the common voltage range 0.1V to 2.3V.
13. fmax generator input conditions: t_R = t_F < 1ns, (0% to 100%), 50% duty cycle, differential (1.05V to1.35V peak to peak). Output Criteria: duty cycle = 60%/40%, V_{OL} (max 0.4V), V_{OH} (min 2.7V), Load = 10pF (stray plus probes).

Parameter Measurement Information

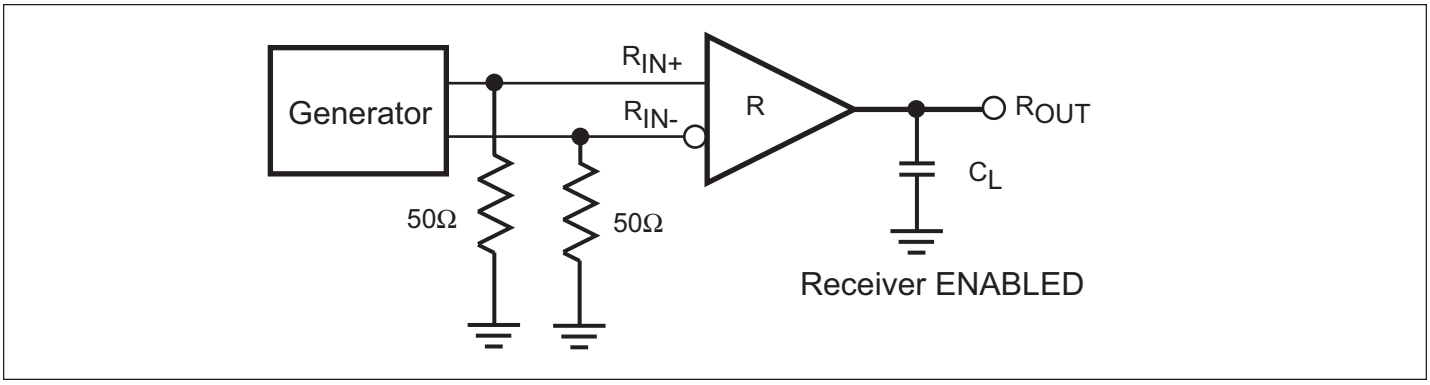


Figure 1. Receiver Propagation Delay and Transition Time Test Circuit

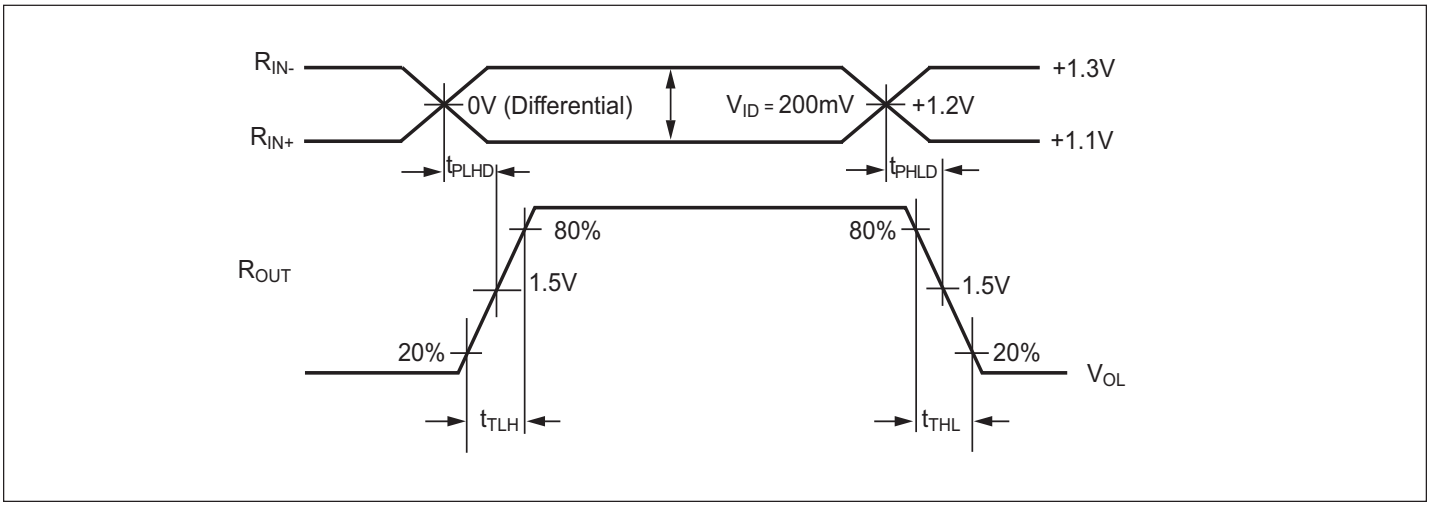


Figure 2. Receiver Propagation Delay and Transition Time Waveforms

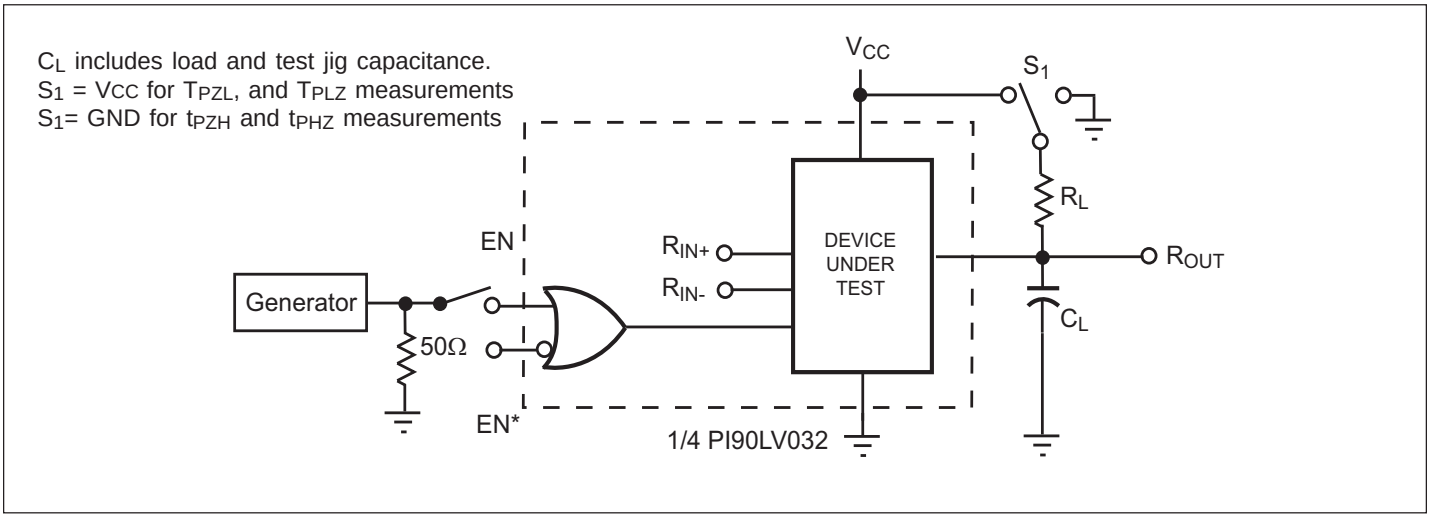


Figure 3. Receiver Three-STATE Delay Test Circuit

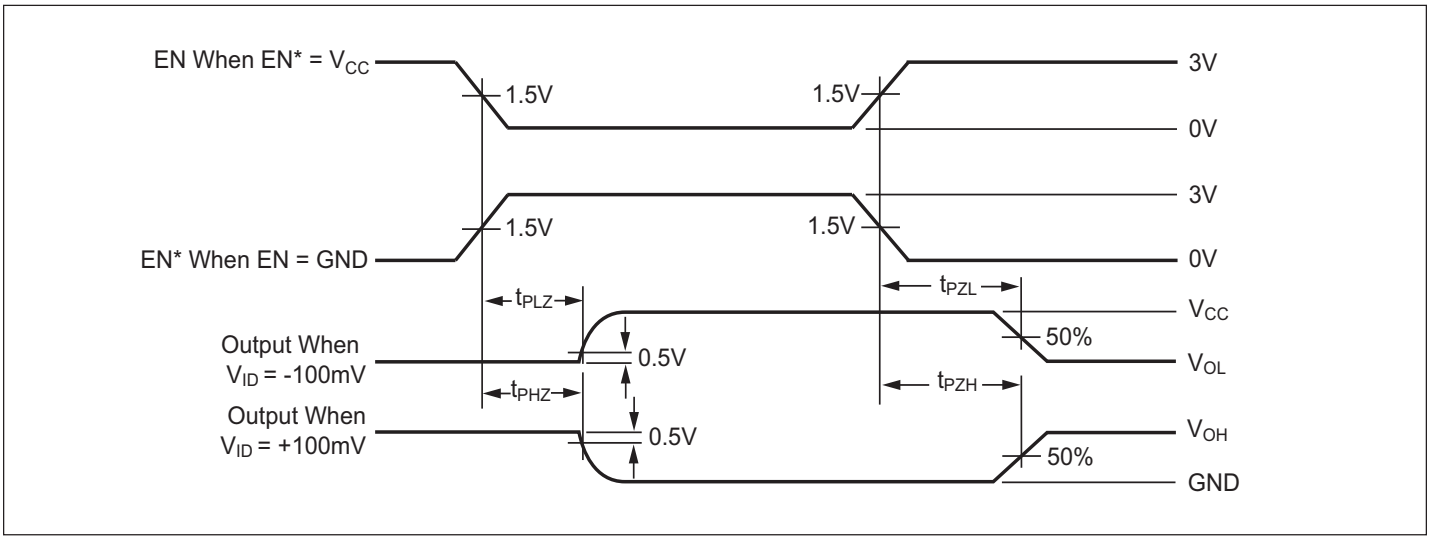


Figure 4. Receiver Three-STATE Delay Waveforms

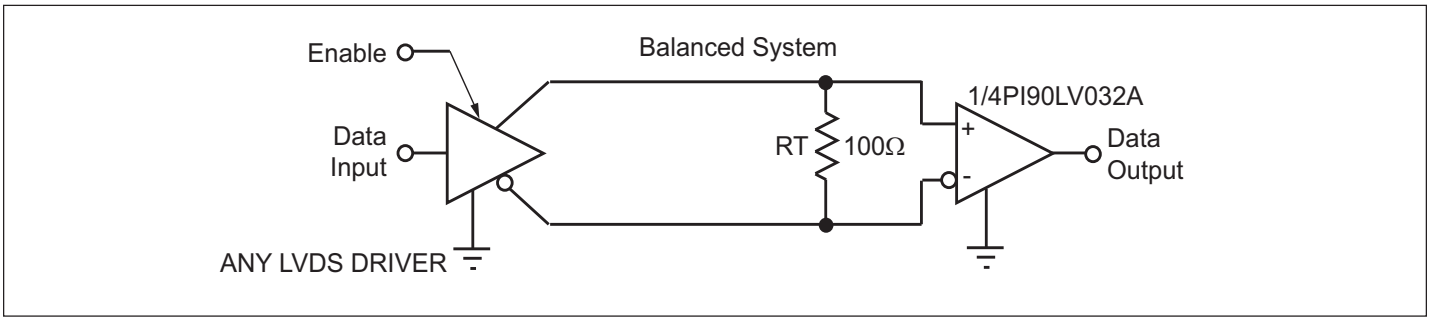
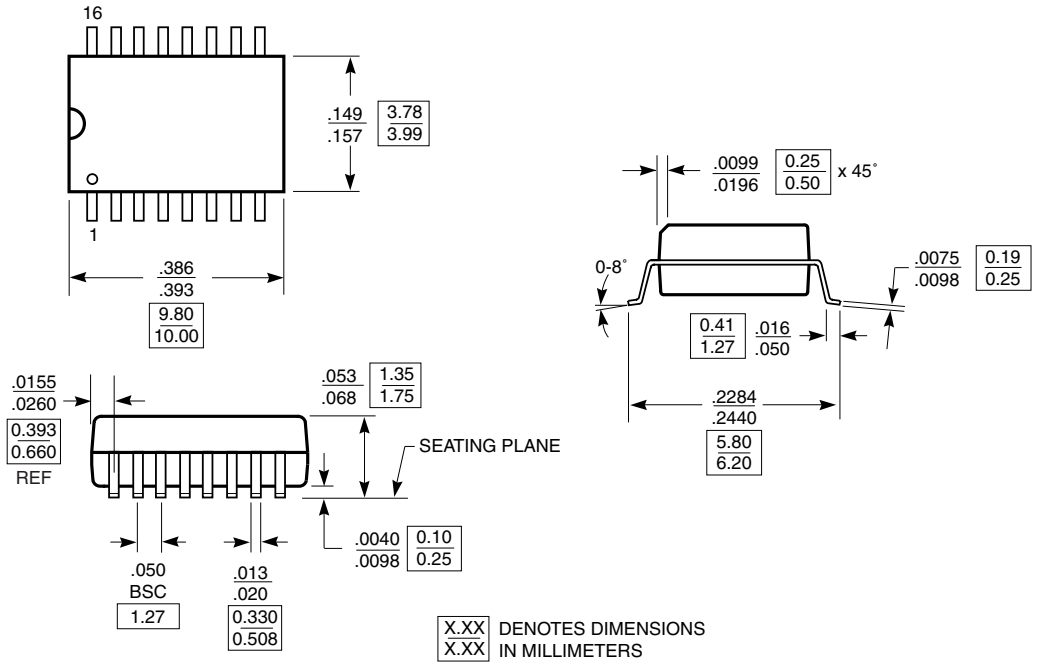
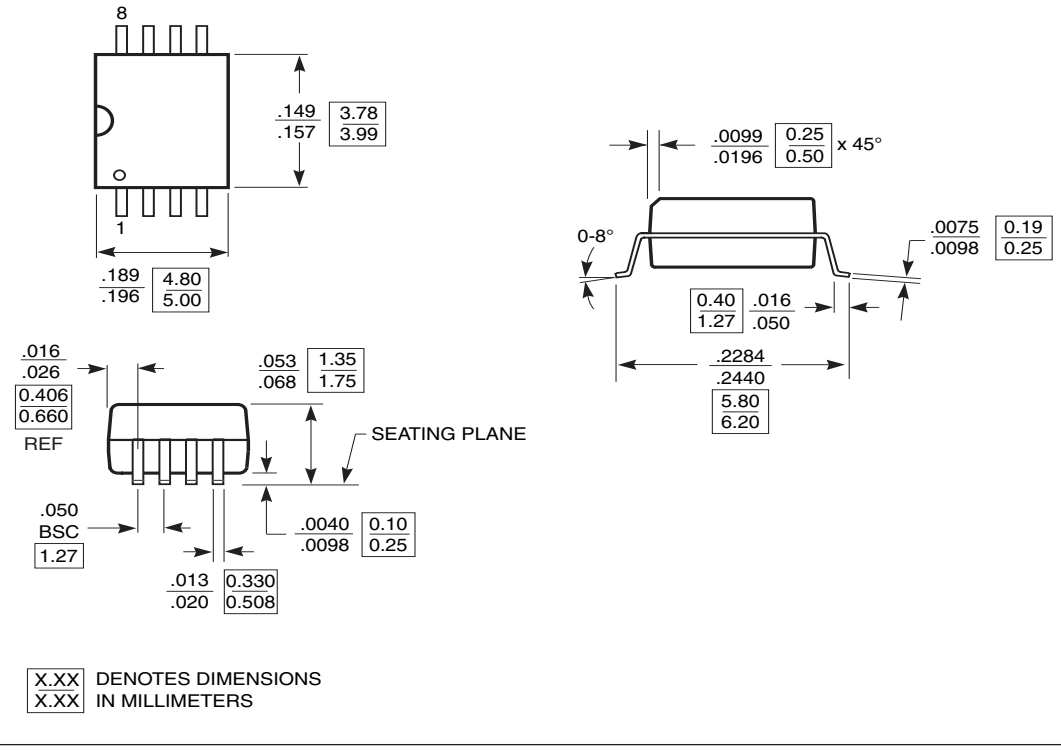


Figure 5. Point-to-Point Application

Packaging Mechanical: 16-Pin SOIC (150 Mil) - W

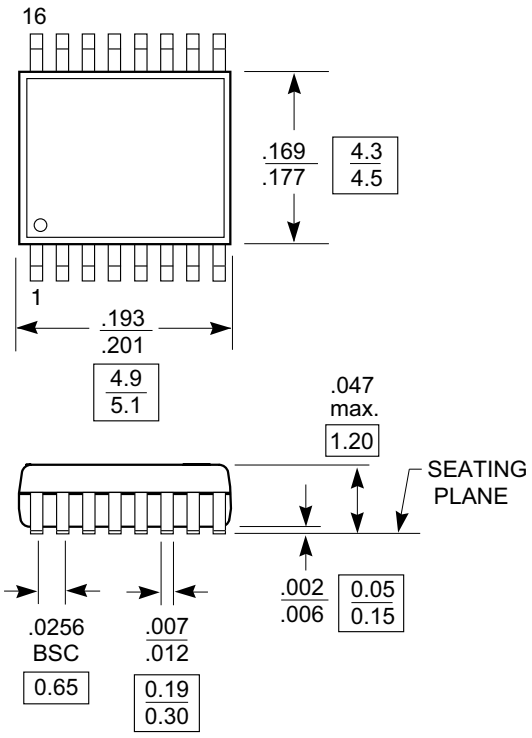


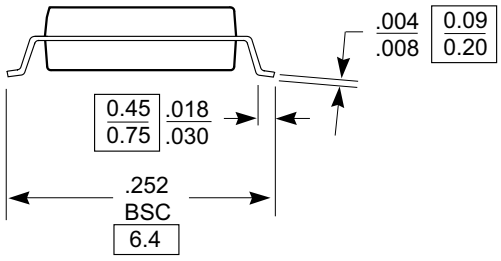
Packaging Mechanical: 8-Pin SOIC (150 Mil) - W



Packaging Mechanical: 16-Pin TSSOP (4.4mm wide) - L

DOCUMENT CONTROL NO. PD - 1310
REVISION: E DATE: 03/09/05





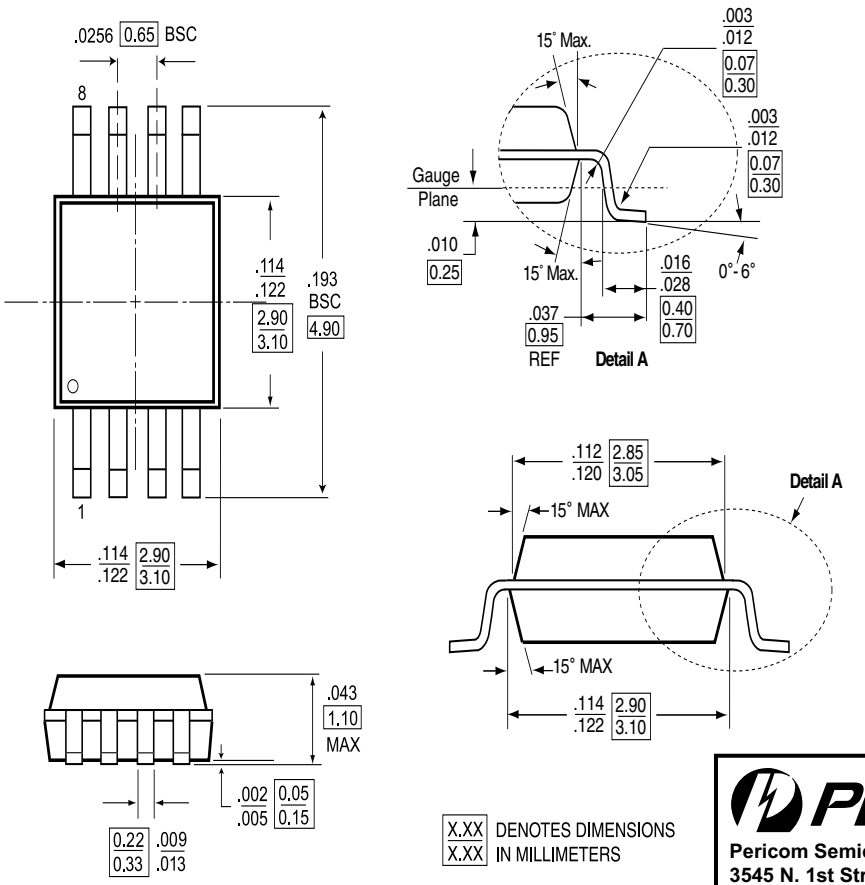
Note:
1. Package Outline Exclusive of Mold Flash and Metal Burr
2. Controlling dimentions in millimeters
3. Ref: JEDEC MO-153F/AB

Pericom Semiconductor Corporation
3545 N. 1st Street, San Jose, CA 95134
1-800-435-2335 • www.pericom.com

DESCRIPTION: 16-Pin, 173-Mil Wide, TSSOP

PACKAGE CODE: L

Packaging Mechanical: 8-Pin Mini Small Outline (MSOP) - U



Notes:
1) Controlling Dimensions inMillimeters
2) Ref. JEDEC MO-187E/AA

DOCUMENT CONTROL NO.
PD - 1261

REVISION: E
DATE: 03/09/05

Pericom Semiconductor Corporation
3545 N. 1st Street, San Jose, CA 95134
1-800-435-2335 • www.pericom.com

DESCRIPTION: 8-Pin Mini Small Outline Package, MSOP

PACKAGE CODE: U

Ordering Information

Ordering Code	Package Code	Package Description
PI90LV032AWE	W	Pb-free & Green, 16-pin SOIC
PI90LV032ALE	L	Pb-free & Green, 16-pin TSSOP
PI90LV028AWE	W	Pb-free & Green, 8-pin SOIC
PI90LV028AUE	U	Pb-free & Green, 8-pin MSOP
PI90LV018AWE	W	Pb-free & Green, 8-pin SOIC
PI90LV018AUE	U	Pb-free & Green, 8-pin MSOP

Notes:
1. Thermal characteristics can be found on the company web site at www.pericom.com/packaging/

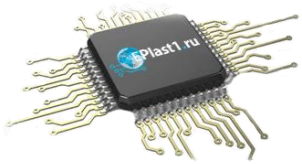
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- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

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- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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